TOSHIBA PHOTOCOUPLER GaAs IRED & PHOTO-TRANSISTOR

TLP285

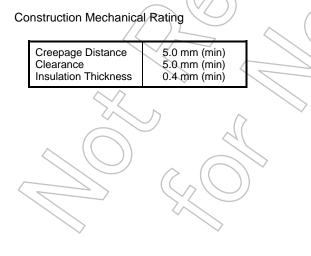
Power Supplies Programmable Controllers Hybrid ICs

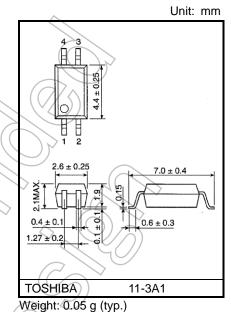
The Toshiba TLP285 consists of photo transistor, optically coupled to a gallium arsenide infrared emitting diode. TLP285 is housed in the SOP4, package, very small and thin coupler.

Since TLP285 is guaranteed wide operating temperature (Ta = -55 to 110 °C) and high isolation voltage (3750 Vrms), it's suitable for high-density surface mounting applications such as small switching power supplies and programmable controllers.

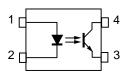
- Collector-Emitter Voltage : 80 V (min)
 - **Current Transfer Ratio** : 50% (min) Rank GB
 - : 100% (min)
 - **Isolation Voltage** : 3750 Vrms (min)
- Guaranteed performance over -55 to 110 °C
- **UL Recognized**
- : UL1577, File No. E67349
- cUL Recognized
- : CSA Component Acceptance Service No.5A, File No. E67349
- Option (V4) : EN60747-5-5 VDE approved Maximum operating insulation voltage : 707 Vpk Highest permissible over-voltage : 6000 Vpk

Note: When a EN60747-5-5 approved type is needed, please designate the "Option(V4)"





Pin Configuration (top view)



1: ANODE 2: CATHODE

3: EMITTER

4: COLLECTOR

Start of commercial production 2008-01

Current Transfer Ratio

	Classification	Current Transfer Ratio (%) (IC/IF)		
TYPE	(Note1)	IF = 5 mA, VCE =	= 5 V, Ta = 25°C	Marking of Classification
		Min	Max	
	Blank	50	600	Blank,Y [∎] , YE, G, G [∎] , GR, B, BL, GB
	Rank Y	50	150	YE, Y■
	Rank GR	100	300	GR, G, G■
	Rank BL	200	600	BL, B
TLP285	Rank GB	100	600	GB, GR, G, G [■] , BL, B
	Rank YH	75	150	Y
	Rank GRL	100	200	G
	Rank GRH	150	300	G
	Rank BLL	200	400	в

Note1: Ex. rank GB: TLP285 (GB)

Note: Application type name for certification test, please use standard product type name, i.e. TLP285 (GB): TLP285

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Absolute Maximum Ratings (Ta = 25°C)

	CHARACTERISTIC	SYMBOL	RATING	UNIT
	Forward Current	IF(RMS)	50	mA
	Forward Current Derating (Ta ≥ 75°C)	∆IF/°C	-1.0	mA/°C
	Pulse Forward Current (Note 1)	I _{FP}	1	A
LED	Reverse Voltage	VR	5	V
	Diode power dissipation	PD	100	(mW)
	Diode power dissipation derating (Ta ≥ 75°C)	∆P _D /°C	-2.0	mW/°C
	Junction Temperature	Тj	125	°C
	Collector-Emitter Voltage	V _{CEO}	80	v
К	Emitter-Collector Voltage	VECO	7	⊳ v
CTO	Collector Current	IC	50	mA
ETE(Collector Power Dissipation	Pc	150	mW
	Collector Power Dissipation Derating (Ta ≥ 25°C)	∆P _C /°C	-1.5	mW/ºC
	Junction Temperature	Тј	125	
Оре	rating Temperature Range	Topr	-55 to 110	30
Stor	age Temperature Range	Tstg	-55 to 125	°C
Lea	d Soldering Temperature (10 s)	Tsol	260	~°C
Tota	al Package Power Dissipation	PT	200	mW
Tota	al Package Power Dissipation Derating (Ta \geq 25°C)	∆P _T /°C	-2.0	mW/°C
Isola	ation Voltage (Note 2)	BVs	3750	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Pulse width \leq 100 μ s, frequency 100 Hz

Note 2: AC, 60 s, R.H.≤60%

Device considered a two terminal device : LED side pins shorted together and DETECTOR side pins shorted together.

	CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
	Forward Voltage	VE	IF = 10 mA	1.0	1.15	1.3	V
CED	Reverse Current	lR	V _R = 5 V		-	10	μA
	Capacitance	Ст	V = 0 V, f = 1 MHz	—	30	—	pF
	Collector-Emitter Breakdown Voltage	V(BR)CEO	I _C = 0.5 mA	80	_	_	V
	Emitter-Collector Breakdown Voltage	V(BR)ECO	I _E = 0.1 mA	7		_	V
TECTOR	Collector Dark Current (Note 2)	laza	$V_{CE} = 48 V,$ Ambient Light Below (100 ℓx) (Note 1)	_	0.01 (2)	0.1 (10)	μΑ
DET	(Note 2)	ICEO	$V_{CE} = 48 \text{ V}, \text{ Ta} = 85^{\circ}\text{C}$ Ambient Light Below (100 ℓ x) (Note 1)		2 (4)	50 (50)	μΑ
	Capacitance (Collector to Emitter)	CCE	V = 0 V, f = 1 MHz		10		pF

Electrical Characteristics (Ta = 25°C)

Note 1: Irradiation to marking side using standard light bulb.

Note 2: Because of the construction, leak current might be increased by ambient light.

Please use photocoupler with less ambient light.

Coupled Electrical Characteristics (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Current Transfer Ratio	IC/IF	IF = 5 mA, VCE = 5 V	50	_	600	%
	IC/IF	Rank GB	100	_	600	70
Saturated CTR	IC/IF(sat)	IF = 1 mA, VCE = 0.4 V	K	60	_	%
Saturated CTR IC/IF(Rank GB	30	1	_	70
		IC = 2.4 mA, IF = 8 mA	X)}	0.4	
Collector-Emitter Saturation Voltage	VCE(sat)	IC = 0.2 mA, IF = 1 mA	/ĸ	0.2	_	V
		Rank GB	A	_	0.4	
OFF-State Collector Current	I _{C(off)}	V _F = 0.7 V, V _{CE} = 48 V		_	10	μA

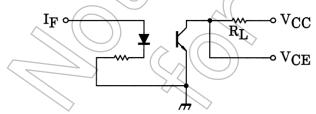
Isolation Characteristics (Ta = 25°C)

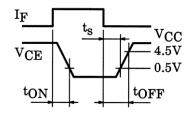
			AL		
SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Cs	Vs = 0 V, f = 1 MHz	$\sim -C$	0.8) —	pF
Rs	V _S = 500 V, R.H.≤60%	1×10 ¹²	1014	_	Ω
	AC, 60 s	3750	~ _	_	Vrma
BVS	AC, 1 s, in OIL	Z	10000	_	Vrms
	DC, 60 s, in OIL	<u></u>	10000	_	Vdc
	Cs Rs	CsVs = 0 V, f = 1 MHzRsVs = 500 V, R.H. \leq 60%AC, 60 sBVsAC, 1 s, in OIL	Cs Vs = 0 V, f = 1 MHz - Rs Vs = 500 V, R.H.≤60% 1x10 ¹² AC, 60 s 3750 BVs AC, 1 s, in OIL	Cs Vs = 0 V, f = 1 MHz - 0.8 Rs Vs = 500 V, R.H.≤60% 1×10^{12} 10^{14} AC, 60 s 3750 - BVs AC, 1 s, in OIL - 10000	Cs Vs = 0 V, f = 1 MHz - 0.8 - Rs Vs = 500 V, R.H.≤60% 1×10^{12} 10^{14} - AC, 60 s 3750 - - BVs AC, 1 s, in OIL - 10000 -

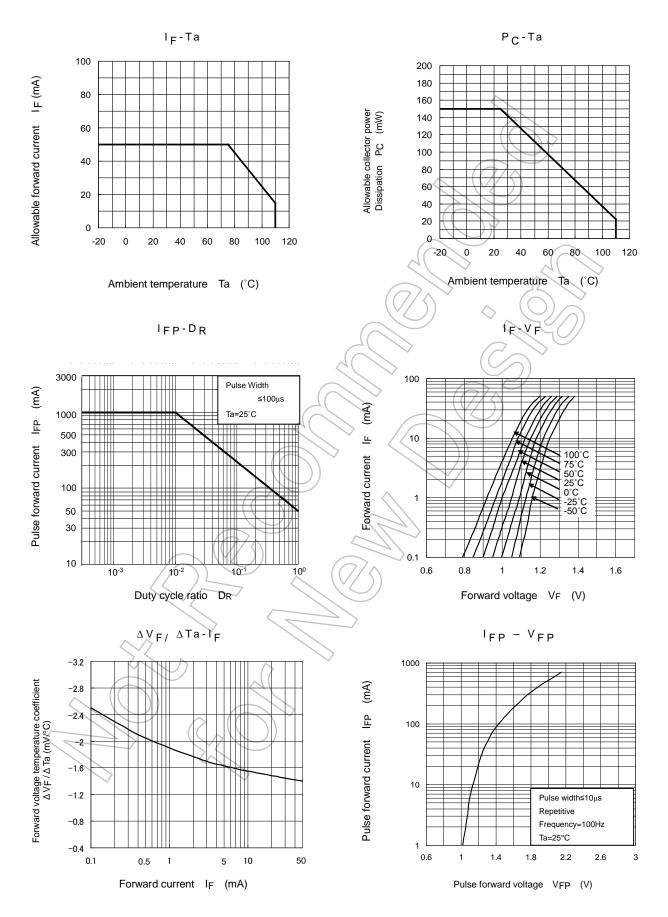
Switching Characteristics (Ta = 25°C)

CHARACT	TERISTIC	SYMBOL	TEST CONDITION		MIN	TYP.	MAX	UNIT
Rise Time		tr			_	2	—	
Fall Time		tr	$V_{CC} = 10 \text{ V}, \text{ I}_{C} = 2 \text{ mA}$ RL = 100 Ω		—	3	—	
Turn-On Time		fon ton	R _L = 100 Ω		_	3	—	μs
Turn-Off Time		toff	(7/5)		_	3	—	
Turn-On Time		ton			_	2	—	
Storage Time		ts	R _L = 1.9 kΩ V _{CC} = 5 V, I _F = 16 mA	(Fig.1)	_	25	—	μs
Turn-Off Time	~	tOFF			_	40	_	

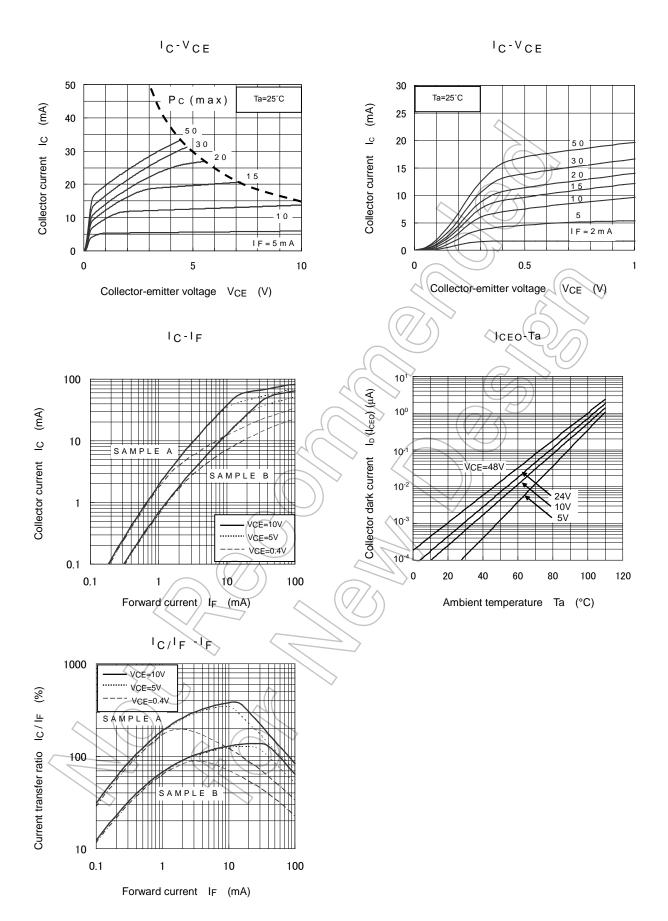
Fig.1: Switching Time Test Circuit



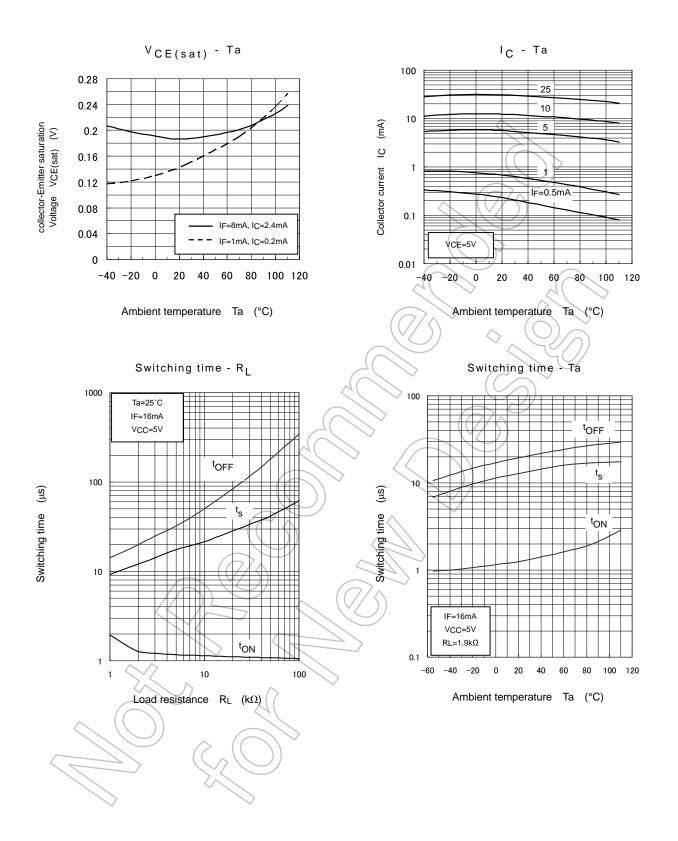




*The above graphs show typical characteristic.



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Soldering and Storage

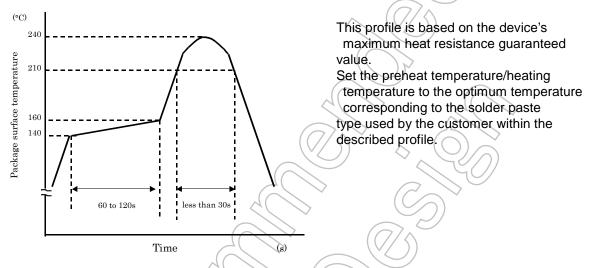
1. Soldering

Soldering

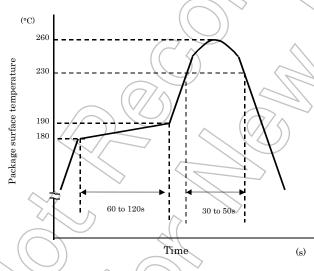
When using a soldering iron or medium infrared ray/hot air reflow, avoid a rise in device temperature as much as possible by observing the following conditions.

1) Using solder reflow

·Temperature profile example of lead (Pb) solder



·Temperature profile example of using lead (Pb)-free solder



This profile is based on the device's maximum heat resistance guaranteed value.

Set the preheat temperature/heating temperature to the optimum temperature corresponding to the solder paste type used by the customer within the described profile.

Reflow soldering must be performed once or twice.

The mounting should be completed with the interval from the first to the last mountings being 2 weeks.

2) Using solder flow (for lead (Pb) solder, or lead (Pb)-free solder)

• Please preheat it at 150°C between 60 and 120 seconds.

• Complete soldering within 10 seconds below 260°C. Each pin may be heated at most once.

3) Using a soldering iron

Complete soldering within 10 seconds below 260°C, or within 3 seconds at 350°C. Each pin may be heated at most once.

2. Storage

- 1) Avoid storage locations where devices may be exposed to moisture or direct sunlight.
- 2) Follow the precautions printed on the packing label of the device for transportation and storage.

3) Keep the storage location temperature and humidity within a range of 5°C to 35°C and 45% to 75%, respectively.

- 4) Do not store the products in locations with poisonous gases (especially corrosive gases) or in dusty conditions.
- 5) Store the products in locations with minimal temperature fluctuations. Rapid temperature changes during storage can cause condensation, resulting in lead oxidation or corrosion, which will deteriorate the solderability of the leads.
- 6) When restoring devices after removal from their packing, use anti-static containers.
- 7) Do not allow loads to be applied directly to devices while they are in storage.
- 8) If devices have been stored for more than two years under normal storage conditions, it is recommended that you check the leads for ease of soldering prior to use.

Embossed-Tape Packing (TP) Specification for Mini-Flat Couplers

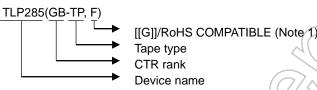
1. Applicable Package

Package	Product Type
SOP4	Mini-Flat Coupler

2. Product Naming System

Type of package used for shipment is denoted by a symbol suffix after a product number. The method of classification is as below.

(Example)



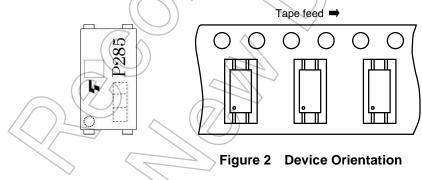
Note 1: Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product.

The RoHS is the Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

3. Tape Dimensions

3.1 Orientation of Device in Relation to Direction of Tape Movement

Device orientation in the recesses is as shown in Figure 2.



- 3.2 Tape Packing Quantity: 2500 devices per reel
- 3.3 Empty Device Recesses Are as Shown in Table 1.

ble 1	Empty	Device	Recesses
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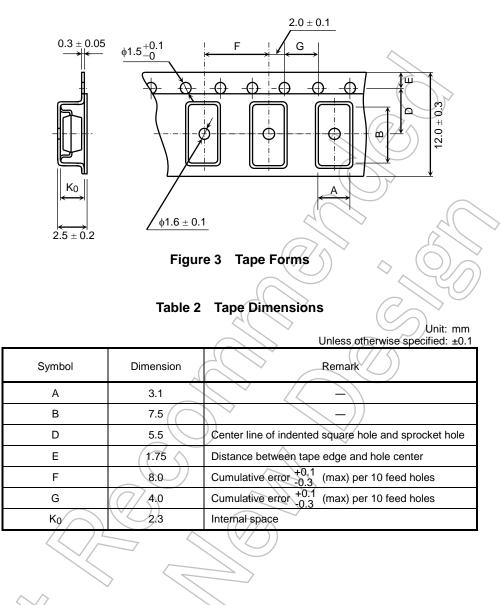
	Standard	Remarks
Occurrences of 2 or more successive empty device recesses	0 device	Within any given 40-mm section of tape, not including leader and trailer
Single empty device recesses	6 device (max.) per reel	Not including leader and trailer

3.4 Start and End of Tape

The start of the tape has 50 or more empty holes. The end of tape has 50 or more empty holes and two empty turns only for a cover tape.

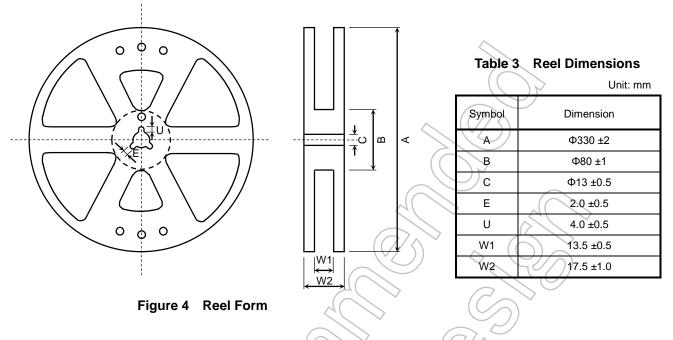
3.5 Tape Specification

- (1) Tape material: Plastic (protection against electrostatics)
- (2) Dimensions: The tape dimensions are as shown in Figure 3 and table 2.



3.6 Reel

- (1) Material: Plastic
- (2) Dimensions: The reel dimensions are as shown in Figure 4 and Table 3.



4. Packing

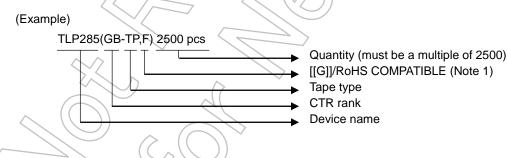
Either one reel or ten reels of photocoupler are packed in a shipping carton.

5. Label Indication

The carton bears a label indicating the product number, the symbol representing classification of standard, the quantity, the lot number and the Toshiba company name.

6. Ordering Method

When placing an order, please specify the product number, the CTR rank, the tape type and the quantity as shown in the following example.



Note 1: Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product.

The RoHS is the Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

EN60747-5-5 Option (V4) Specification

Types : TLP285 (Note 1)

Type designations for "option: $(\sqrt{4})$ ", which are tested under EN60747 requirements.

Ex.: TLP285 (V4-GB-TP,F)

V4 : EN60747 option GB : CTR rank type TP : Standard tape & reel type F : [[G]]/RoHS COMPATIBLE (Note 2)

Note 1: Use TOSHIBA standard type number for safety standard application.

Ex.: TLP285 (V4-GB-TP,F) \rightarrow TLP285

Note 2: Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product.

The RoHS is the Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

EN60747 Isolation Characteristics

Description	Symbol	Rating	Unit
Application classification	\odot)	
for rated mains voltage ≤ 150Vrms for rated mains voltage ≤ 300Vrms	(Z)	I-IV I-III	_
Climatic classification		55 / 110 / 21	_
Pollution degree		2	_
Maximum operating insulation voltage	VIORM	707	Vpk
Input to output test voltage, Method A Vpr=1.6 × VIORM, type and sample test tp=10s, partial discharge<5pC	Vpr	1131	Vpk
Input to output test voltage, Method B Vpr=1.875 × VIORM, 100% production test tp=1s, partial discharge<5pC	Vpr	1325	Vpk
Highest permissible overvoltage (transient overvoltage, tpr=60s)	VTR	6000	Vpk
Safety limiting values (max. permissible ratings in case of fault, also refer to thermal derating curve) current (input current IF, Psi=0) power (output or total power dissipation) temperature	lsi Psi Tsi	250 400 150	mA mW °C
Insulation resistance VIO=500V, Ta=Tsi	Rsi	≥ 10 ⁹	Ω

Insulation Related Specifications

Minimum creepage distance	Cr	5.0 mm
Minimum clearance	CI	5.0 mm
Minimum insulation thickness	ti	0.4 mm
Comparative tracking index	CTI	175

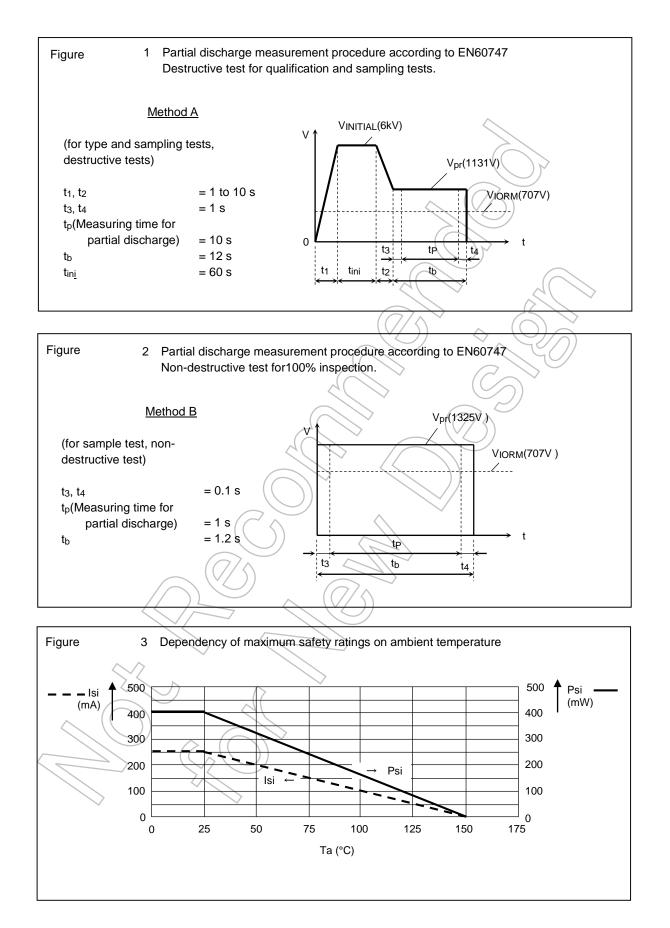
Note: If a printed circuit is incorporated, the creepage distance and clearance may be reduced below this value. If this is not permissible, the user shall take suitable measures.

Note: This photocoupler is suitable for 'safe electrical isolation' only within the safety limit data. Maintenance of the safety data shall be ensured by means of protective circuit,

VDE test sign:

Marking on packing VDE Marking Example CTR Rank Marking Mark for option(V4) Type name P285 1pin indication Lot No.

<u>TOSHIBA</u>



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